

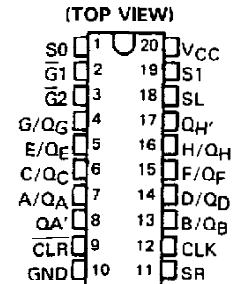
# SN54LS323, SN74LS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

SDLS160

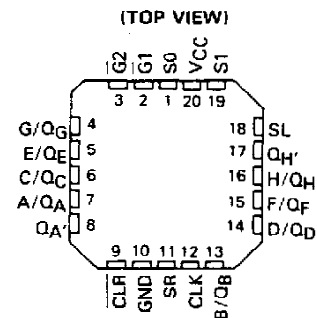
OCTOBER 1976 — REVISED MARCH 1988

- Multiplexed Inputs/Outputs Provide Improved Bit Density
- Four Modes of Operation:
  - Hold (Store)    Shift Left
  - Shift Right    Load Data
- Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- Typical Power Dissipation . . . 175 mW
- Exceptionally Stable Shift (Clock) Frequency . . . 25 MHz
- Applications:
  - Stacked or Push-Down Registers, Buffer Storage, and Accumulator Registers
- SN54LS299 and SN74LS299 Are Similar But Have Direct Overriding Clear

SN54LS323 . . . J OR W PACKAGE  
SN74LS323 . . . DW OR N PACKAGE



SN54LS323 . . . FK PACKAGE



### description

These Low-Power Schottky eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table. Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. The clear function is synchronous, and a low level at the clear input clears the register on the next low-to-high transition of the clock.

FUNCTION TABLE

MODE	INPUTS				INPUTS/OUTPUTS								OUTPUTS					
	CLR	FUNCTION SELECT		OUTPUT CONTROL	CLK	SERIAL		A/QA	B/QB	C/QC	D/QD	E/QE	F/QF	G/QG	H/QH	QA'	QH'	
		S1	S0	G1†		G2†	SL											SR
Clear	L	X	L	L	L	†	X	X	L	L	L	L	L	L	L	L	L	
	L	L	X	L	L	†	X	X	L	L	L	L	L	L	L	L	L	
	L	H	H	X	X	†	X	X	X	X	X	X	X	X	X	X	X	
Hold	H	L	L	L	L	X	X	X	QA0	QB0	QC0	QD0	QE0	QF0	QG0	QH0	QA0	QH0
	H	X	X	L	L	L	X	X	QA0	QB0	QC0	QD0	QE0	QF0	QG0	QH0	QA0	QH0
Shift Right	H	L	H	L	L	†	X	H	H	QA <sub>n</sub>	QB <sub>n</sub>	QC <sub>n</sub>	QD <sub>n</sub>	QE <sub>n</sub>	QF <sub>n</sub>	QG <sub>n</sub>	H	QH <sub>n</sub>
	H	L	H	L	L	†	X	L	L	QA <sub>n</sub>	QB <sub>n</sub>	QC <sub>n</sub>	QD <sub>n</sub>	QE <sub>n</sub>	QF <sub>n</sub>	QG <sub>n</sub>	L	QH <sub>n</sub>
Shift Left	H	H	L	L	L	†	H	X	QB <sub>n</sub>	QC <sub>n</sub>	QD <sub>n</sub>	QE <sub>n</sub>	QF <sub>n</sub>	QG <sub>n</sub>	QH <sub>n</sub>	H	QA <sub>n</sub>	H
	H	H	L	L	L	†	L	X	QB <sub>n</sub>	QC <sub>n</sub>	QD <sub>n</sub>	QE <sub>n</sub>	QF <sub>n</sub>	QG <sub>n</sub>	QH <sub>n</sub>	L	QA <sub>n</sub>	L
Load	H	H	H	X	X	†	X	X	a	b	c	d	e	f	g	h	a	h

†When one or both output controls are high the eight input/output terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

a . . . h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals.

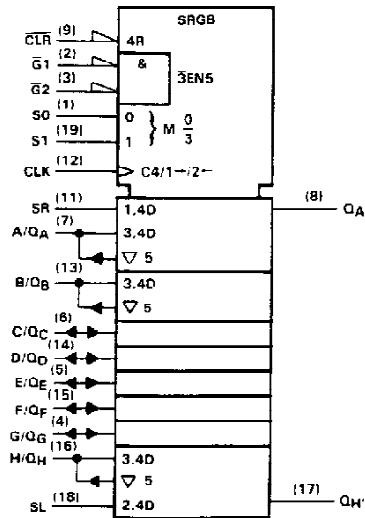
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

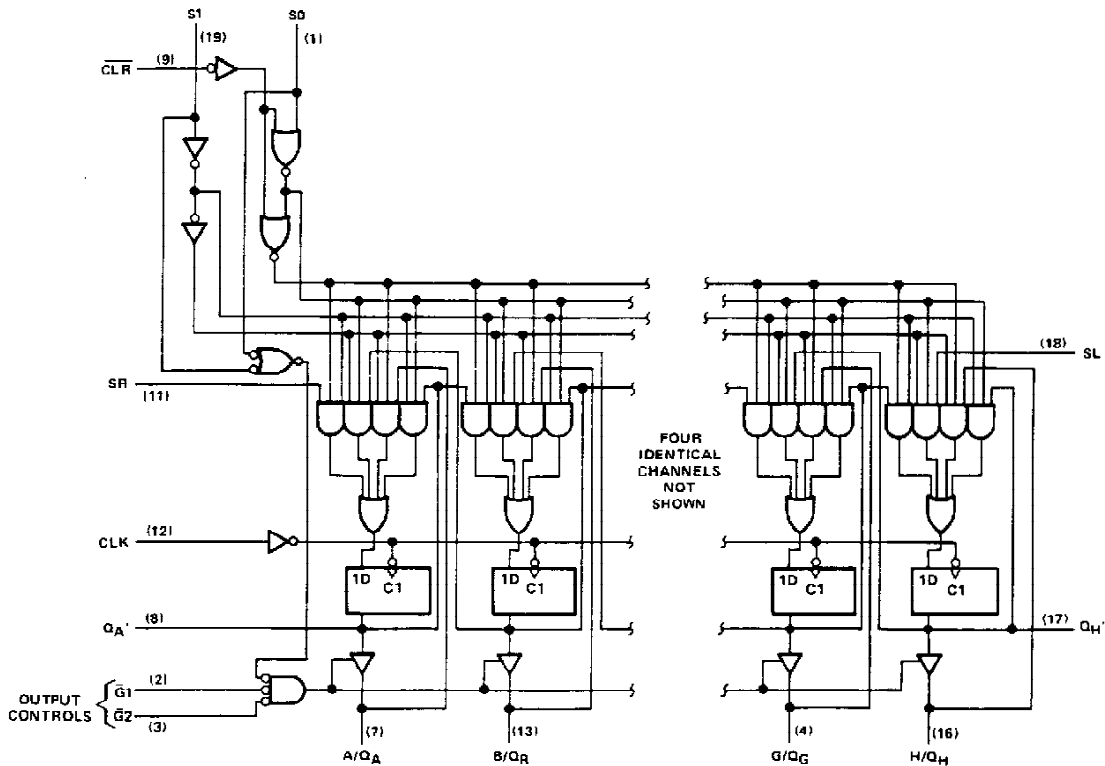
# SN54LS323, SN74LS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

logic symbol†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

logic diagram (positive logic)



INPUTS/OUTPUTS NOT SHOWN:  
(6) C/QC (14) D/QD (15) E/QE (15) F/QF

Pin numbers shown are for DW, J, N, and W packages.

**TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

**SN54LS323, SN74LS323**  
**8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS**

schematics of inputs and outputs, absolute maximum ratings, recommended operating conditions, and electrical characteristics

Same as SN54LS299 and SN74LS299, except  $t_{SU}$  (Clear Inactive) does not apply.

switching characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$f_{max}$			See Note 1	25	35		MHz
$t_{PLH}$	CLK	$Q_A'$ or $Q_H'$	$C_L = 15\text{ pF}$ , $R_L = 2\text{ k}\Omega$		22	33	ns
$t_{PHL}$					26	39	
$t_{PLH}$	CLK	$Q_A$ thru $Q_H$	$C_L = 45\text{ pF}$ , $R_L = 665\ \Omega$		17	25	ns
$t_{PHL}$					25	39	
$t_{PZH}$	$\bar{G}1, \bar{G}2$	$Q_A$ thru $Q_H$	$C_L = 45\text{ pF}$ , $R_L = 665\ \Omega$		14	21	ns
$t_{PZL}$					20	30	
$t_{PHZ}$	$\bar{G}1, \bar{G}2$	$Q_A$ thru $Q_H$	$C_L = 5\text{ pF}$ , $R_L = 665\ \Omega$		10	20	ns
$t_{PLZ}$					10	15	

† $f_{max}$  = maximum clock frequency

$t_{PLH}$  = Propagation delay time, low-to-high-level output

$t_{PHL}$  = Propagation delay time, high-to-low-level output

$t_{PZH}$  = Output enable time to high level

$t_{PZL}$  = Output enable time to low level

$t_{PHZ}$  = Output disable time from high level

$t_{PLZ}$  = Output disable time from low level

NOTE 1: For testing  $f_{max}$ , all outputs are loaded simultaneously, each with  $C_L$  and  $R_L$  as specified for the propagation times. Load circuits and voltage waveforms are shown in Section 1.

  
**TEXAS**  
**INSTRUMENTS**

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

## IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

## **IMPORTANT NOTICE**

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

**TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.**

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

## IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

This datasheet has been downloaded from:

[www.DatasheetCatalog.com](http://www.DatasheetCatalog.com)

Datasheets for electronic components.